**PRODUCTS** ∨

APPLICATION ~

**FOUNDRY** ~

**SUPPORT** ~ **INSIGHTS** 

**ABOUTUS** ~



# CHECK OUT NOW THAT HISTORY IS CREATED!

**€** eMMC KLMCG8WEBD-B031

64 GB eMMC 5.0

## KLMCG8WEBD-B031

**OVERVIEW** 

**SPECIFICATIONS** 

**RELATED RESOURCES** 

The eMMC architecture for embedded memory devices contains not only a data storage element (such as NAND flash memory), but also the controller for the storage element integrated on the same silicon die; it allows devices and applications to maintain the required data rates and throughputs for high-density chips. Along with the abilities to store high-resolution video and provide extended data storage capabilities, this results in reduced development time and easier integration of the memory block in the overall system, and a much shorter time-to-market for the end product.

Moreover, the eMMC is capable of operating at significantly high interface speeds, and provides the designer the flexibility to select the data transfer bus widths and interface voltages. eMMC is also extensively used for platforms that require high levels of performance in very small form factors, such as mobile handsets, and smartphones.

Samsung has the widest range of high performance memory devices based on the eMMC architecture. Worldwide, Samsung eMMC devices are preferred by a majority of system designers, integrators, and OEMs for their flexible configurability, high operating speeds and data transfer bandwidths, low power consumption, and small form factors.

## **SPECIFICATIONS**

### EMMC > KLMCG8WEBD-B031

Production Status	EOL	Density	64 GB
Package Size	11.5x13x1.0	Temperature(°C)	-25°C ~ 85°C
Version	5.0	MLC	3bit MLC
Application	Smart Phone, Tablet, Smart TV, Game Console		

# RELATED RESOURCES

Brochure (3)



#### **SUBSCRIPTION**

Stay connected with our experts' latest view on industry and technology trend.

**Email Address** 

SEND

I would like to be notified by email of future case studies, white papers, webinars and other educational content.

I have read and agree to the Terms & Conditions.

#### CONTACT US

We'll help you find the solution that's right for your business.

EMAIL US

## **FOLLOW US**









### SALES NETWORK

You can find our sales network

Find out more •

B2B WORKPLACE
Partner site for B2B collaboration

Find out more •



# PRODUCTS

DRAM

- Server DRAM
- PC DRAM
- Mobile DRAM
- Consumer DRAM
- Graphic DRAM

Flash Storage

- V-NAND Technology
- Client SSD
- Enterprise SSD
- -eMMC
- UFS
- МСР
- eMMC Based MCP
- ePoP

About Us

Exynos Solution

- Application Processor
- ModAP
- Modem/RF

ISOCELL Image Sensor

- Mobile CIS
- Industry CIS
- Display Solution
- Mobile DDI
- Panel DDI/TCON
- Touch Controller
- Security Solution
- Smart Card
- NFC Power IC
- Bio-Processor

#### **APPLICATION**

Data Center

- **-** Web Server
- Application Server
- **-** DB Server
- \* Storage Server
- Mobile Device
- Smartphone
- **-** Tablet
- Wearable Consumer Device
- Desktop
- Notebook
- Smart TV
- Game Console
- By Industry
- Automotive
- Industrial
- Banking/ID
- Healthcare & Wellness

# FOUNDRY

About Samsung Foundry

Manufacturing

Process Technology

- 14nm
- 32/28nm
- 4511111 45nm
- Corvice
- Service
- Design Solution
- MPW Shuttle Service
- Mask Service
- Back-end Service
- E-service

# MORE SITES

LED []

Display ☑ B2B Workplace ☑

Worker Safety ☐ MemoryLink ☐ Exynos ☐

Artik ☐ Simband ☐

Privacy/Legal Sitemap

Copyright© 1995-2017 SAMSUNG All Rights Reserved.

Insights

This website is best viewed using Internet Explorer 9 , Chrome , Safari and newer browsers.

Technical Resources

Selection Tools

Back to top 🔷

